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## Editor Contact

**Eva Heigl**  
Marketing Communications Manager  
Central European Region  
Tel.: +49 89 741313-184  
[eva.heigl@ni.com](mailto:eva.heigl@ni.com)

**Stefan Ambrosch**  
Ad & PR Specialist  
Tel.: +49 89 741313-136  
[stefan.ambrosch@ni.com](mailto:stefan.ambrosch@ni.com)

**Florian Schultz**  
Ad & PR Specialist  
Tel.: +49 89 741313-294  
[florian.schultz@ni.com](mailto:florian.schultz@ni.com)

## Reader Contact

**Germany:**  
National Instruments Germany GmbH  
Ganghoferstraße 70 b  
80339 München  
Tel.: +49 89 7413130  
Fax: +49 89 7146035  
[ni.com/germany](http://ni.com/germany)  
[info.germany@ni.com](mailto:info.germany@ni.com)

**Austria:**  
National Instruments GesmbH  
Plainbachstraße 12  
5101 Salzburg-Bergheim  
Tel.: +43 662 457990-0  
Fax: +43 662 457990-19  
[ni.com/austria](http://ni.com/austria)  
[ni.austria@ni.com](mailto:ni.austria@ni.com)

**Switzerland:**  
National Instruments Switzerland GmbH  
Sonnenbergstrasse 53  
5408 Ennetbaden  
Tel.: +41 56 2005151  
Fax: +41 56 2005155  
[ni.com/switzerland](http://ni.com/switzerland)  
[ni.switzerland@ni.com](mailto:ni.switzerland@ni.com)

## NI Lowers Semiconductor ATE Cost With PXI-Based Test Systems

**Open, platform-based approach combines modular instrumentation and system design software for RF and mixed-signal production test**

NI (Nasdaq: NATI), the provider of solutions that enable engineers and scientists to solve the world's greatest engineering challenges, today announced the NI Semiconductor Test System (STS) series. These [PXI](#)-based automated test systems reduce test cost for RF and mixed-signal devices by opening access to NI- and industry-offered PXI modules in semiconductor production test environments. Compared to conventional semiconductor automated test equipment (ATE), STS lead users are experiencing reduced production costs and increased throughput and can now perform both characterization and production with the same hardware and software tools. This decreases data correlation time and time to market.

"As integrated circuit complexity grows exponentially, cost-effective ATE that provides optimal test coverage in applications from design verification to end-of-line production test is increasingly important," said Dr. Hans-Peter Kreuter, senior design and application engineer for automotive body power products at Infineon Technologies. "For mixed-signal test, the PXI-based STS outperforms what we typically see in traditional ATE with optimal test coverage at a very low cost."

The open, modular architecture of STS gives engineers access to cutting-edge [PXI instrumentation](#), unlike traditional ATE with its closed architecture. This is particularly important for RF and mixed-signal test, as the requirements of the latest semiconductor technologies often outpace the test coverage provided by traditional ATE. Powered by [TestStand](#) test management software and [LabVIEW](#) system design software, STS comes with a rich set of features for semiconductor production environments, including a customizable operator interface, handler/prober integration, device-centric programming with pin-channel mapping, standard test data format reporting and integrated multisite support. With these features, engineers can quickly develop, debug and deploy test programs, shortening overall time to market. Additionally with the fully enclosed "zero-footprint" test head, standard interfacing and docking mechanics, STS comes ready to integrate into a semiconductor production test cell.

"Traditional ATE systems require major costly retooling efforts on the test floor as generations of test systems become obsolete or unable to meet new test requirements, but the nature of the open PXI architecture of the STS helps us retain our original investment and build upon it, rather than throw it away," said Glen Peer, director of test for Integrated Device Technology (IDT). "It provides the flexibility we need to reconfigure and grow our test platforms in parallel with our growing performance needs."



The STS series includes three different models named T1, T2 and T4, which accommodate one, two and four PXI chassis, respectively. These varying sizes, along with common software, instrumentation and interconnect mechanics across all STS models give engineers the ability to optimize for a wide range of pin-count and site-count requirements. Additionally, the scalability of STS makes it practical to deploy from characterization to production with the benefit of not only optimized cost, but greatly simplified data correlation to further shorten time to market.

To ensure customer success, NI provides training, products and services supported by NI engineering professionals and NI Alliance Partners throughout the world.

For availability and configuration assistance, contact your local NI sales engineer. To learn more about the NI Semiconductor Test System, visit [www.ni.com/sts](http://www.ni.com/sts).

### **About National Instruments**

Since 1976, NI ([www.ni.com](http://www.ni.com)) has made it possible for engineers and scientists to solve the world's greatest engineering challenges with powerful, flexible technology solutions that accelerate productivity and drive rapid innovation. Customers from a wide variety of industries—from healthcare to automotive and from consumer electronics to particle physics—use NI's integrated hardware and software platform to improve the world we live in.